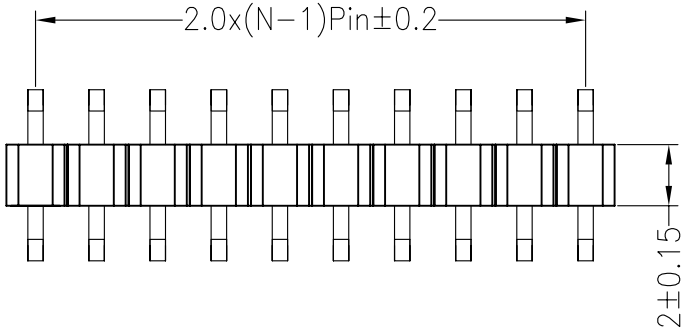
HSF RoHS

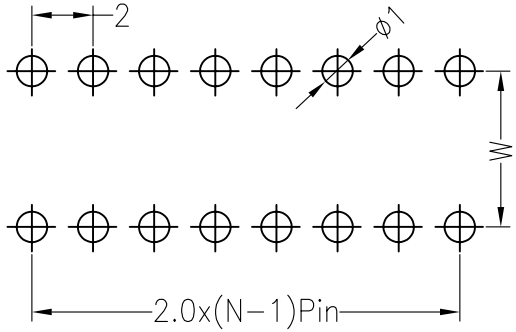
FILE NO :E362810

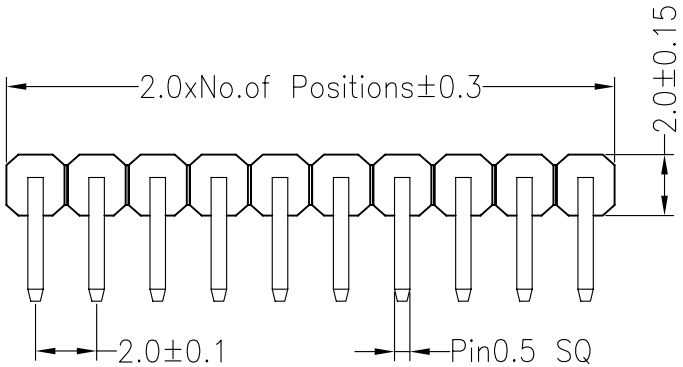
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

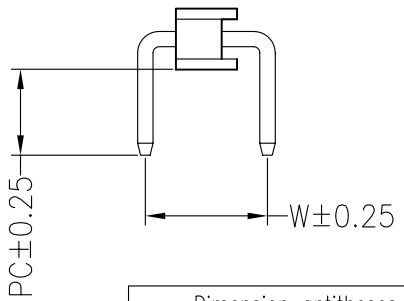
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1320 11 XX X N XX U XXX X 02

No.of Pins Per Row 1x40 1−−40	Insulator Material Option	Contact Plating	Pin Length	Packing
	A=BK−PBT	G0:Gold Flash		0=PE Bag
	B=BK−PA66	G2:5U" Gold		A=Tray
	C=BK−PA6T	G3:10U" Gold		T=Tube
	D=BK−PA46	G4:15U" Gold		
	F=BK−LCP	G5:30U" Gold		
		S0:Gold Flash/Tin		
		SN:Tin		

Dimension antitheses list			
ITEM	PC	W	L
Standard	2.80	4.00	11.00
Alternate			

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.10.08	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.10.08
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	132011XXXNXXUXXXX02
TITLE:	2.0PH 1xNpin H2.0mm U−Type